PATENT TESSERA 3.0-115 CONT CIP

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of Joseph Fjelstad

Group Art Unit:

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LEADS AND METHODS

THEREFOR

Х Assistant Commissioner for Patents

Washington, D.C. 20231

INFORMATION DISCLOSURE STATEMENT

Sir:

It is respectfully requested that the references listed on the enclosed Form PTO-1449 be made of record and considered with respect to the above-referenced U.S. patent application. copy of each reference was of record in U.S. Patent Application Nos. 09/520,320 and 09/271,688, the benefit of which is claimed under § 120. Submission of the present Information Disclosure Statement should not be taken as an admission that the cited references are legally available prior art or that the same are pertinent or material.

Respectfully submitted,

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